## **Power MOSFET 22 Amps, 60 Volts** N-Channel TO-220 and D<sup>2</sup>PAK

Designed for low voltage, high speed switching applications in power supplies, converters and power motor controls and bridge circuits.

#### **Typical Applications**

- Power Supplies
- Converters
- Power Motor Controls
- Bridge Circuits

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

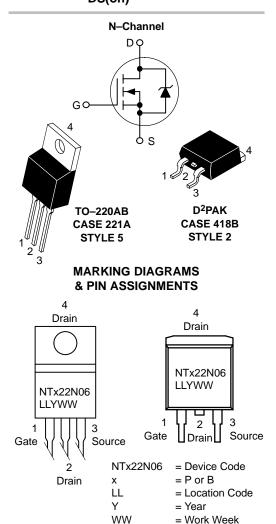
Rating	Symbol	Value	Unit		
Drain-to-Source Voltage	V <sub>DSS</sub>	60	Vdc		
Drain–to–Gate Voltage ( $R_{GS}$ = 10 M $\Omega$ )	V <sub>DGR</sub>	60	Vdc		
Gate–to–Source Voltage – Continuous – Non–Repetitive (t <sub>p</sub> ≤10 ms)	V <sub>GS</sub> V <sub>GS</sub>	±20 ±30	Vdc		
Drain Current - Continuous @ $T_A = 25^{\circ}C$ - Continuous @ $T_A = 100^{\circ}C$ - Single Pulse ( $t_p \le 10 \ \mu s$ )	I <sub>D</sub> I <sub>D</sub> I <sub>DM</sub>	22 10 66	Adc Apk		
Total Power Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	PD	60 0.4	W W/∘C		
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C		
$            Single Pulse Drain-to-Source Avalanche \\             Energy - Starting T_J = 25^\circ C \\              (V_{DD} = 50 Vdc, V_{GS} = 10 Vdc, L = 1.0 mH, \\              V_{DS} = 60 Vdc, I_{L(pk)} = 12 A, RG = 25 \Omega )                                 $	E <sub>AS</sub>	72	mJ		
Thermal Resistance – Junction–to–Case – Junction–to–Ambient	R <sub>θJC</sub> R <sub>θJA</sub>	2.5 62.5	°C/W		
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	ΤL	260	°C		



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## 22 AMPERES 60 VOLTS R<sub>DS(on)</sub> = 60 mΩ



## ORDERING INFORMATION

Device	Package	Shipping			
NTP22N06	TO-220AB	50 Units/Rail			
NTB22N06	D <sup>2</sup> PAK	50 Units/Rail			
NTB22N06T4	D <sup>2</sup> PAK	800/Tape & Reel			

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
$\begin{array}{l} \text{Drain-to-Source Breakdown}\\ (\text{V}_{\text{GS}}=0 \text{ Vdc}, \text{ I}_{\text{D}}=250 \ \mu\text{A}\\ \text{Temperature Coefficient (Pos} \end{array}$	V <sub>(BR)DSS</sub>	60 -	71 71		Vdc mV/°C	
Zero Gate Voltage Drain Cur ( $V_{DS} = 60 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}$ ( $V_{DS} = 60 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}$	I <sub>DSS</sub>			1.0 10	μAdc	
Gate-Body Leakage Current	I <sub>GSS</sub>	-	-	±100	nAdc	
ON CHARACTERISTICS (Not	e 1.)					
Gate Threshold Voltage (Not $(V_{DS} = V_{GS}, I_D = 250 \mu Add Threshold Temperature Coefficients (V_DS = 100 \mu Add Threshold Temperature Coefficients)$	V <sub>GS(th)</sub>	2.0	3.09 7.0	4.0	Vdc mV/°C	
Static Drain–to–Source On–F (V <sub>GS</sub> = 10 Vdc, I <sub>D</sub> = 11 Add	R <sub>DS(on)</sub>	_	52	60	mΩ	
Static Drain-to-Source On-V ( $V_{GS} = 10$ Vdc, $I_D = 22$ Ad ( $V_{GS} = 10$ Vdc, $I_D = 11$ Ad	V <sub>DS(on)</sub>		1.2 1.11	1.6 -	Vdc	
Forward Transconductance (	9 <sub>FS</sub>	-	12	-	mhos	
OYNAMIC CHARACTERISTIC	S					
Input Capacitance		C <sub>iss</sub>	-	502	700	pF
Output Capacitance	$(V_{DS} = 25 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}, f = 1.0 \text{ MHz})$	Coss	-	160	225	
Transfer Capacitance	,	C <sub>rss</sub>	-	46	65	
SWITCHING CHARACTERIS	TICS (Note 2.)					
Turn–On Delay Time		t <sub>d(on)</sub>	-	12	25	ns
Rise Time	$(V_{DD} = 30 \text{ Vdc}, I_D = 22 \text{ Adc},$	t <sub>r</sub>	-	39	80	
Turn–Off Delay Time	$V_{GS} = 10 \text{ Vdc}, R_G = 9.1 \Omega$ (Note 1.)	t <sub>d(off)</sub>	-	18	40	
Fall Time		t <sub>f</sub>	-	34	70	
Gate Charge	(V <sub>DS</sub> = 48 Vdc, I <sub>D</sub> = 22 Adc, V <sub>GS</sub> = 10 Vdc) (Note 1.)	QT	-	15.5	32	nC
		Q <sub>1</sub>	-	3.4	-	
		Q <sub>2</sub>	-	7.7	-	
SOURCE-DRAIN DIODE CH	RACTERISTICS					
Forward On–Voltage	$(I_{S} = 22 \text{ Adc}, V_{GS} = 0 \text{ Vdc}) \text{ (Note 1.)}$ $(I_{S} = 22 \text{ Adc}, V_{GS} = 0 \text{ Vdc}, T_{J} = 150^{\circ}\text{C})$	V <sub>SD</sub>		1.07 1.0	1.15 -	Vdc
Reverse Recovery Time		t <sub>rr</sub>	-	43	-	ns
	$(I_{S} = 22 \text{ Adc}, V_{GS} = 0 \text{ Vdc}, dI_{S}/dt = 100 \text{ A}/\mu\text{s}) (Note 1.)$	t <sub>a</sub>	-	32	-	1
		t <sub>b</sub>	_	11	-	
				-		

Reverse Recovery Stored Charge

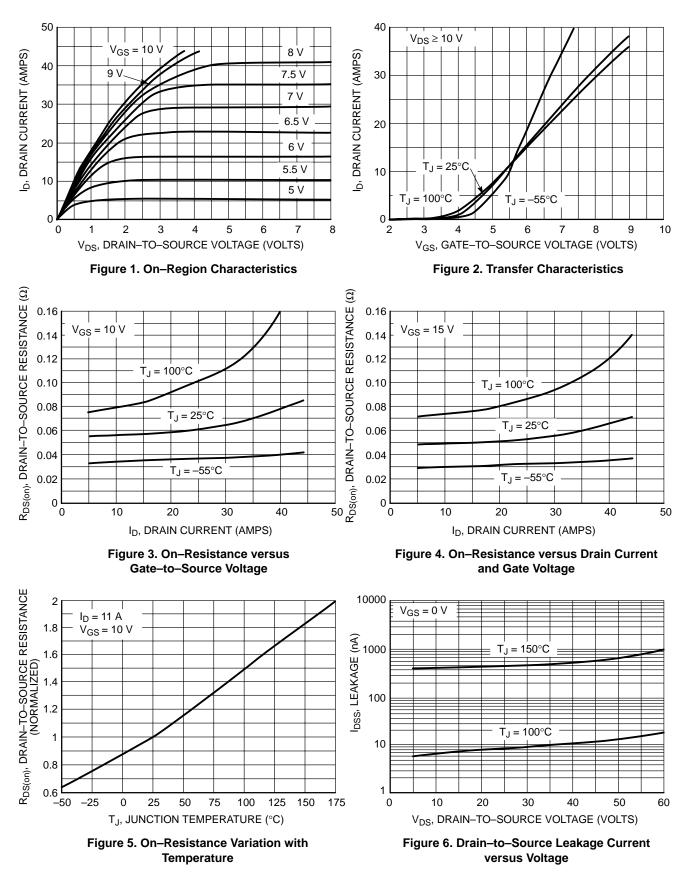
Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

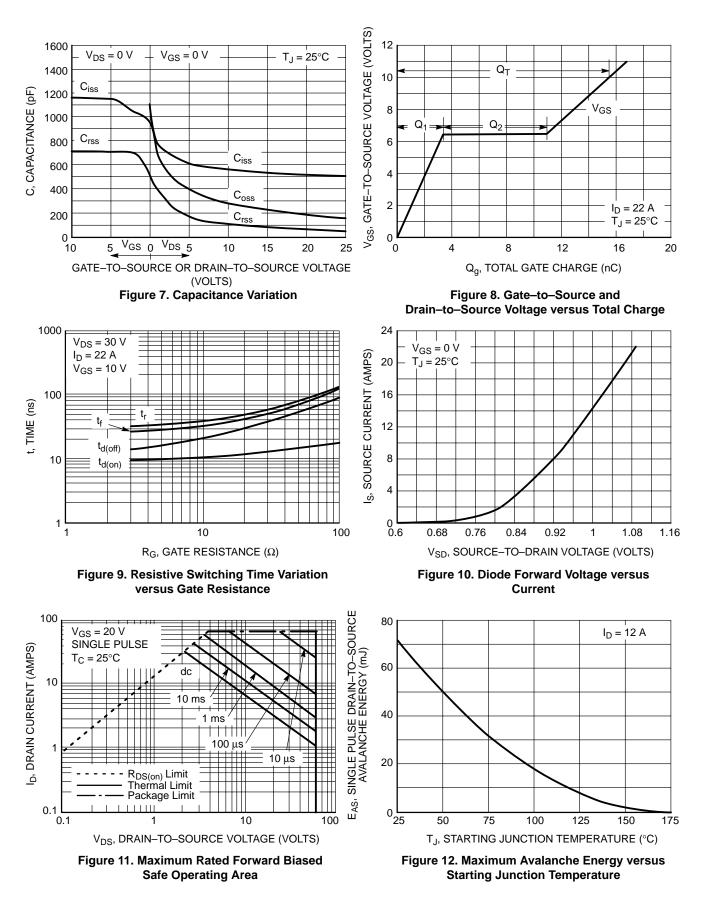
μC

\_

0.071

 $\mathsf{Q}_{\mathsf{R}\mathsf{R}}$ 





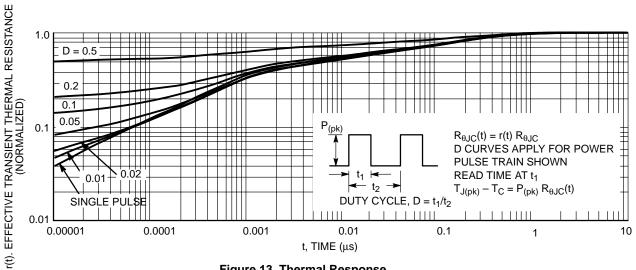


Figure 13. Thermal Response

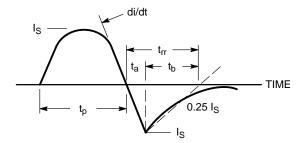
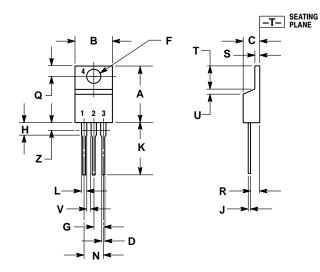


Figure 14. Diode Reverse Recovery Waveform

#### PACKAGE DIMENSIONS

TO-220 THREE-LEAD TO-220AB CASE 221A-09 **ISSUE AA** 



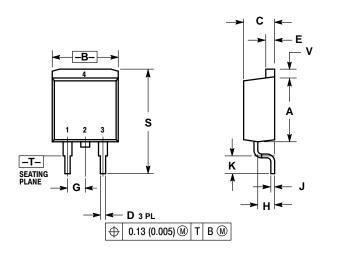
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.42	2.66	
Η	0.110	0.155	2.80	3.93	
J	0.018	0.025	0.46	0.64	
Κ	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
Ν	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
۷	0.045		1.15		
Z		0.080		2.04	

PIN 1. GATE 2. DRAIN

#### PACKAGE DIMENSIONS

D<sup>2</sup>PAK CASE 418B–03 ISSUE D



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIM	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.340	0.380	8.64	9.65
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
Е	0.045	0.055	1.14	1.40
G	0.100 BSC		2.54 BSC	
Н	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
Κ	0.090	0.110	2.29	2.79
S	0.575	0.625	14.60	15.88
٧	0.045	0.055	1.14	1.40

STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

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